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F	DEC 3 1 2003	=	01-07	-2004	Attorney Docket No.: 44471/28760					
) اِ د	(Revised 03/01)	R			U.S. Department of Commerce U.S. Patent and Trademark Office					
,   <u> </u>	OMB No. 0651-0027 (exp. 5/31/2002)  To the Honorable Commissioner f	for Patents	and Trademarks	9994	ed original documents or copy thereof.					
. 』	Name of conveying party(ies):			2. Name and address of receiving party(ies):						
	Tomohiko Imada, Seiji Watanabe and T Additional names of conveying party(ies) a	•		Name: Address:	Kabushiki Kaisha Toshiba 1-1, Shibaura 1-chome, Minato-ku Tokyo, Japan					
	☐ YES ☒ NO			Additional name(s) and address(es) attached?  Tyes No						
3	3. Nature of conveyance:	<del></del>			·					
	X Assignment	N	Merger		Other:					
	Security Agreement	Security Agreement Change of Name								
I	Execution Date(s): November 20, 2003									
	Application number(s) or patent number(s):  f this document is being filed together with a new application, the execution date of the application is:									
	A. Patent Application No.(s): 10/617,931	фрисан	sii, iie execution	B. Patent No.(s):						
-	Additional numbers attached?  \[ YES \] NO									
	5. Name and address of party to whom correspond document should be mailed:	dence con	cerning	6. Total number of applications and patents involved: 1						
1 1 2	John S. Pratt, Esq. KILPATRICK STOCKTON LLP 1100 Peachtree Street, Suite 2800 Atlanta, Georgia 30309-4530 (404) 815-6500									
1	7. Total fee (37 CFR 3.41): \$40.00									
8										
	9. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.    Brenda O. Holmes   December 29, 2003									
	Total Number of Pages Including Cover Sheet, Att	tachments	, and Document:	3						

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## **ASSIGNMENT**

The undersigned Inventor(s),

in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, does (do) hereby sell, transfer, and assign to the Assignee,

## KABUSHIKI KAISHA TOSHIBA

a corporation organized and existing under the laws of <u>Japan</u>, and having a place of business at <u>1-1</u>, <u>Shibaura 1-chome</u>, <u>Minato-ku</u>, <u>Tokyo</u>, <u>Japan</u>

the full, exclusive, and entire right, title, and interest for the territory of the United States of America, in and to the invention entitled

## SYSTEM, METHOD AND COMPUTER PROGRAM PRODUCT FOR DESIGNING CONNECTING TERMINALS OF SEMICONDUCTOR DEVICE

as described and claimed in the application for Letters Patent executed by me (us) on the <u>20th</u> day of <u>November</u>, 20 03; and the full, exclusive and entire right, title, and interest in and to said application, in and to any divisions, continuations, reexaminations, and reissues thereof; and I(we) hereby request the Commissioner of Patents and Trademarks of the United States of America to issue said Letters Patent to the Assignee, for its interest, for the sole use of the Assignee and its successors, assigns and legal representatives, as fully and entirely as the same would have been held by me (us) had this assignment not been made;

AND, for the same consideration, I (we) agree to sign all lawful papers, execute all division, continuing, reexamination, reissue and other applications, make all assignments and rightful oaths, and generally do everything possible to the Assignee, its successors, assigns, and nominees, to obtain and enforce proper protection for all said inventions and improvements in the United States of America.

I (we) hereby authorize and request my (our) attorney,

		` ′		_				_	• /	• •			
Reg.	No	<b></b> ,	to	insert	here	in	parenthes	es	the	application	n number	(App.	No.
10/	617 <b>,</b> 931	_) and	fili	ng date	e ( <u>Ju</u>	lу	11 2003 C	of th	ne afo	oresaid app	lication wh	nen kno	wn.
Date	Signed: No	Vover	vembe	r 20,		m	ehi	iko d	mada				
				200	3		(Inv	ento	or) To	omohiko IM	ADA		

PATENT REEL: 014849 FRAME: 0010

J&A Docket:	
Date Signed: November 20,	Seiji Watamabe
2003	(Inventor) Seiji WATANABE
Date Signed: November 20,	Joyokazu Shibata (Inventor) Toyokazu SHIBATA
2003	(Inventor) Toyokazu SHIBATA

**RECORDED: 12/31/2003** 

PATENT REEL: 014849 FRAME: 0011